

Electronic Acknowledgement Receipt

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Confirmation Number:	8034
Title of Invention:	Complex laminated chip element
First Named Inventor/Applicant Name:	In-Kil Park
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.)
1	Information Disclosure Statement (IDS) Filed (SB/08)	US_IDS_Form__SB_08a.pdf	612815 eb4de285a3f99004b567fd8f58e5b400c31334cb	no	5

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2		IDS-cited-2-25-10-a.pdf	17926917	yes	113
			548f20e6815c8d256c97bb78a3f263d6ad1f1530		
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	Document Description		Start	End	
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3		IDS-cited-2-25-10-b.pdf	4464936	yes	53
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